

PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Vernon M. Williams and  
Michael D. Gifford

Attorney Docket No.: 501062.01

Filed : Concurrently Herewith

Title : LEADFRAME AND METHOD FOR REDUCING MOLD COMPOUND ADHESION PROBLEMS

J10000 U.S. Pro  
09/974958  
10/10/01


**GENERAL AUTHORIZATION**

Box Patent Application  
Commissioner of Patents  
Washington, D.C. 20231

Sir:

With respect to the above-identified application, the Commissioner is authorized to charge any fees under 37 C.F.R. §§ 1.16 and 1.17 which may be required and to treat any concurrent or future reply requiring a petition for an extension of time under 37 C.F.R. § 1.136(a)(3) for its timely submission as incorporating a petition therefor for the appropriate length of time and to charge any fees which may be required during the course of prosecution, or credit any overpayment, to Deposit Account No. 50-1266.

Date October 10, 2001
  
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